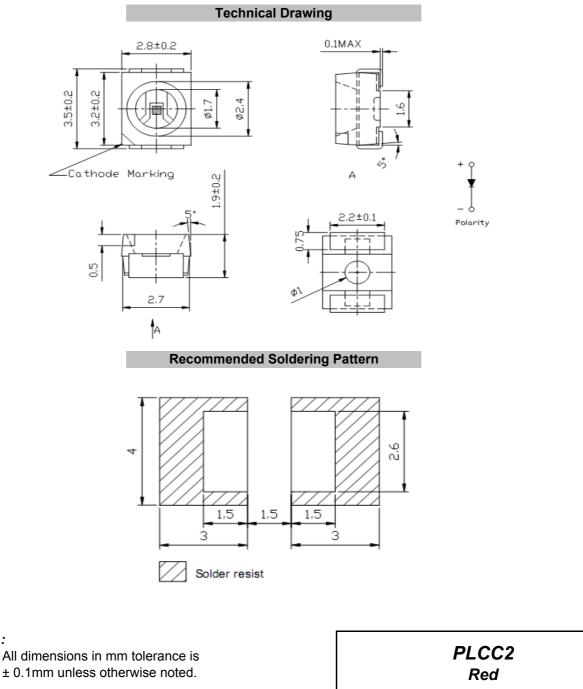




Applications



					Part No.	.: M1 1	A1036
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Notes :





Absolute Maximum Ratings

Ta=25°C

Item	Symbol	 Unit
Power Dissipation	PD	 mW
DC Forward Current	I _F	 mA
Plused Forward Current	I _{FP} *	 mA
Reverse Voltage	V _R	 V
Operating Temperature	T _{OP}	 °C
Storage Temperature	T _{ST}	 °C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Red					
Material							
Forward Voltage	typ.		V _F				
Torward Voltage	max.		V _F				
Wavelength	λD	620	nm				
-	λP		nm				
typ.	Δλ		nm				
Color Temperature	min.		K				
color remperature	max.		K				
Luminous Intensity *	min.	150	mcd				
Editifious intensity	typ.	200	mcd				
Reverse Current	max.		μA				
Viewing Angle	2Θ1/2	120					

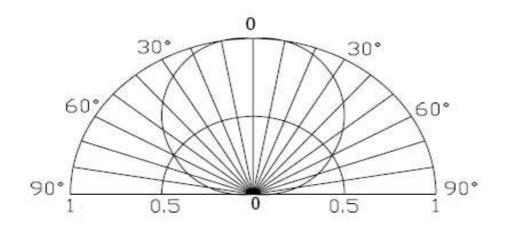
* Per NIST standards

						PLCC2 Red			
					Part No.	: M11	A1036		
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Directive Characteristics



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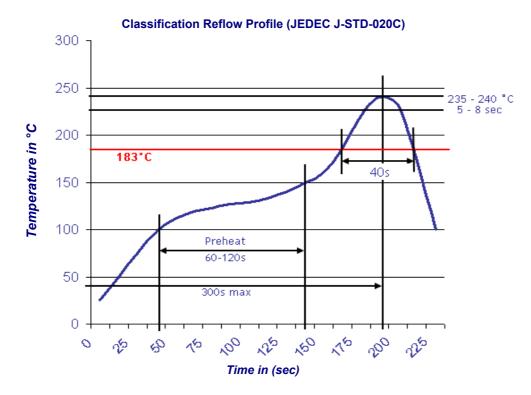
				PLCC2 Red			
					Part No	.: M11/	A1036
					Custome	er:	
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Solder Condition

Lead Free Solder



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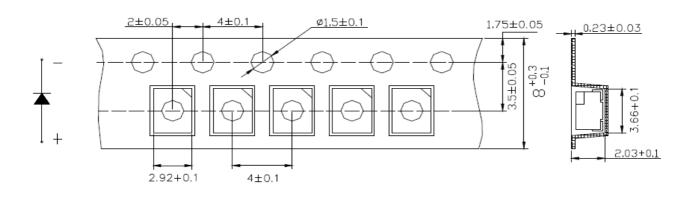
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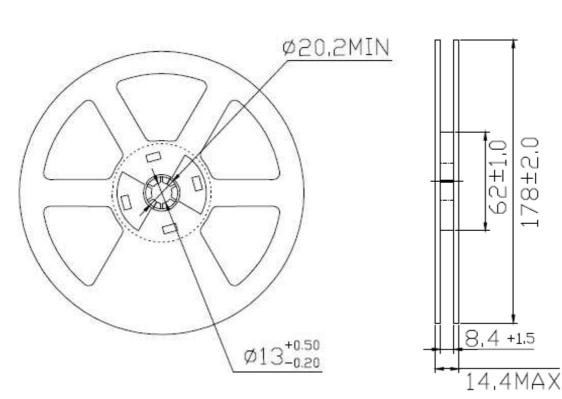




Packing Specifications



Reel Specifications



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178±2.0

62±1.0

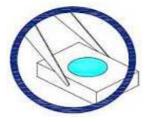




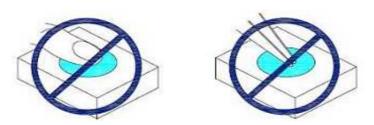
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.

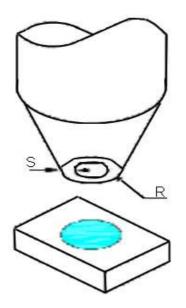


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					Part No	.: M11A	A1036
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



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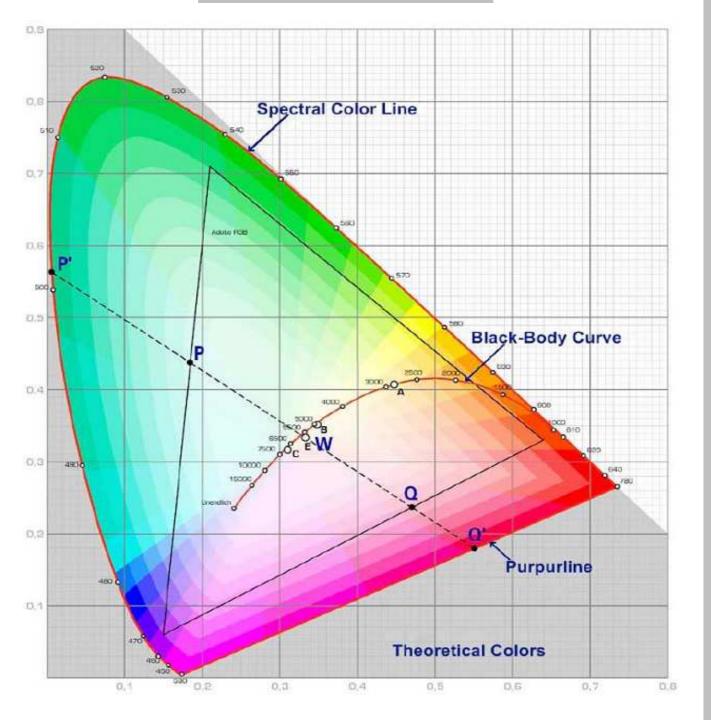
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Color table curve



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